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# Roadblocks to High Efficiency Solid-State Lighting: Bridging the “Green-Yellow Gap”

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Acknowledgements: DOE Office of Basic Energy Sciences  
Laboratory Directed Research and Development Program  
National Institute of Nanoengineering

**Sandia is a multiprogram laboratory operated by Sandia Corporation, a Lockheed Martin Company, for the United States  
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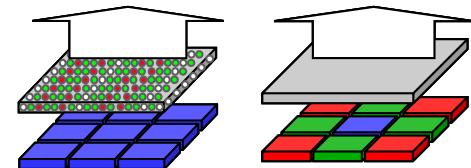
# OUTLINE

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## Roadblocks to Ultra-high Efficiency Solid-State Lighting: the “Green-Yellow Gap”

### I. Introduction

- A. Solid-State White lighting Approaches
- B. Present performance limitations and predicted future performance
- C. InGaN materials challenges at long wavelengths



### II. Research Strategies for Overcoming the Gap

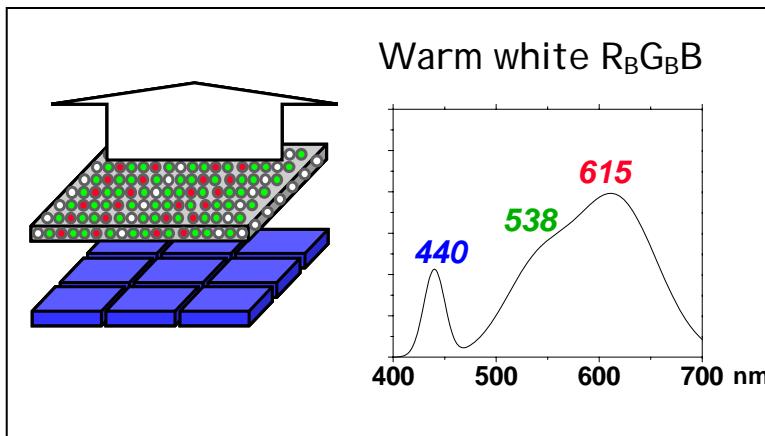
- A. Polarization mitigation strategies
- B. Strain management approaches
- C. Nanostructured materials and devices

### III. Conclusions

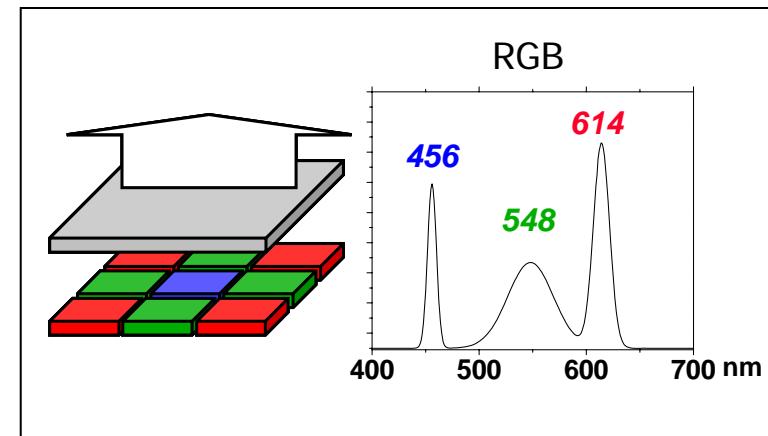
# Solid-State White Lighting Approaches

## Approaches:

### Phosphor-converted

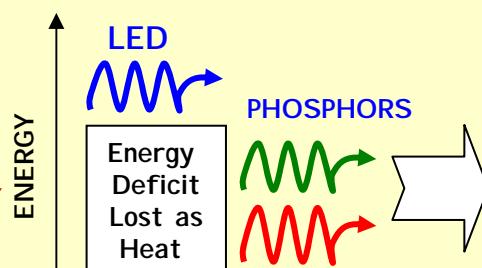


### Multi-chip ( all LED)



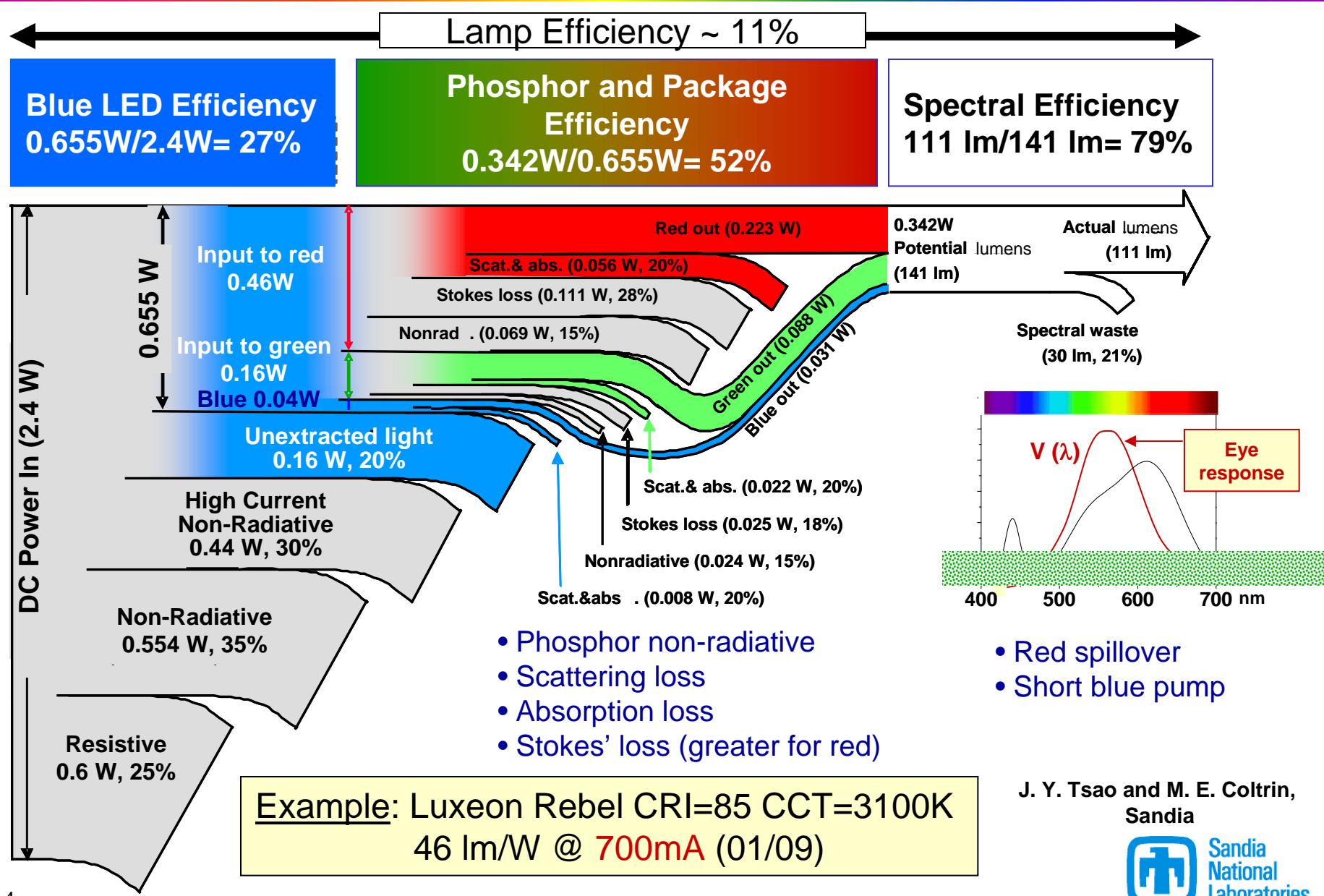
## Advantages/limitations:

- Requires high performance LED only in blue region
- Simpler operation
- Inherent losses (*pump absorption, phosphor efficiency, Stokes' loss*)
- Requires high performance green and red phosphors (suitable for blue pump)

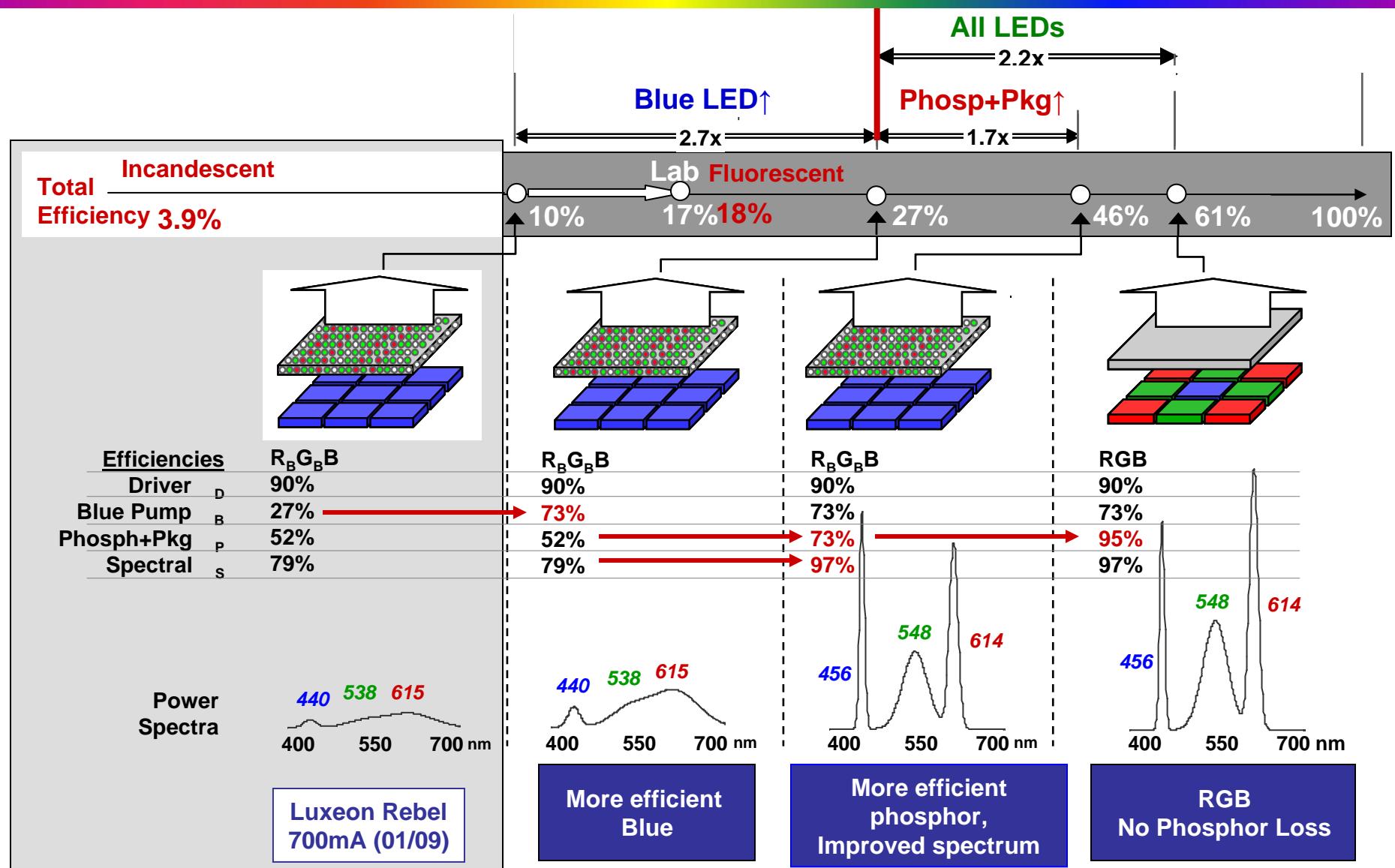


- Direct light emission from LEDs → highest efficiencies
- Greater automation and color control possibilities ("smart lighting")
- Requires high performance from LEDs across the spectrum
- More complex operation (drive circuitry, disparate LED degradation)

# Phosphor-converted Warm White LED Power Flow

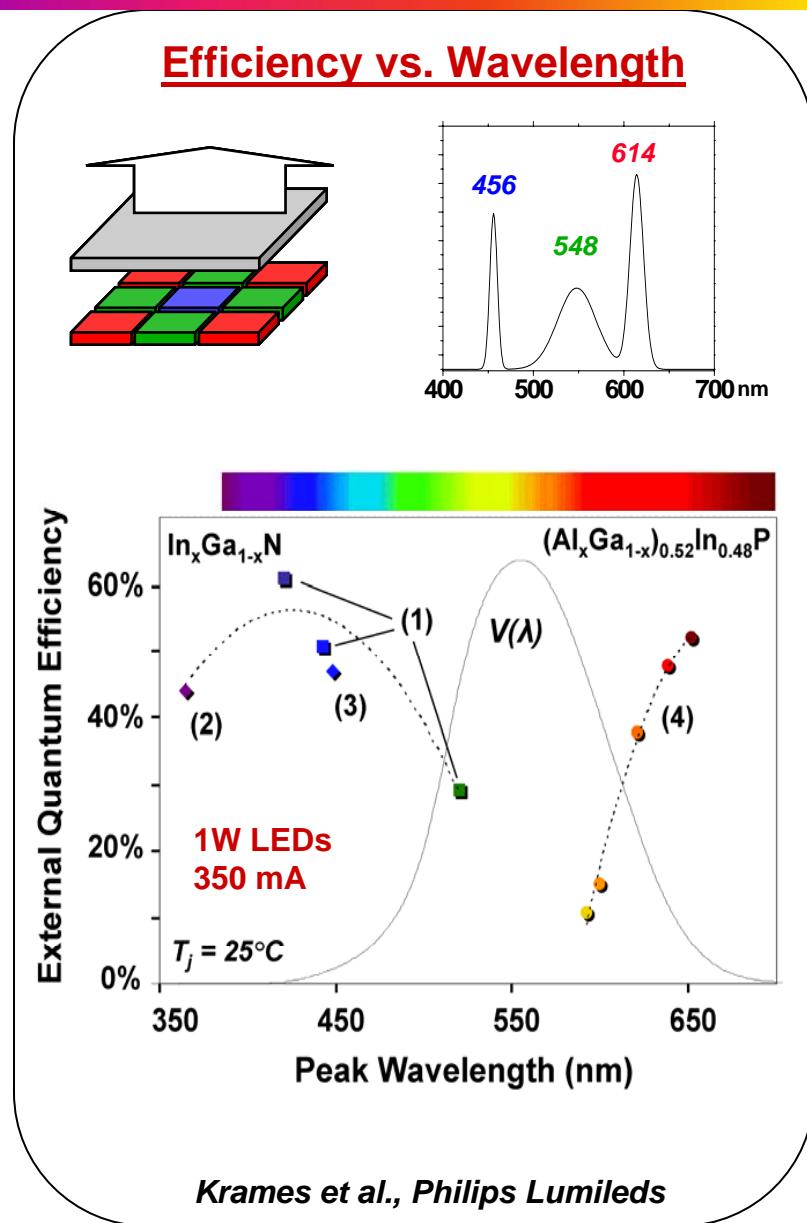


# Future White Lighting Performance

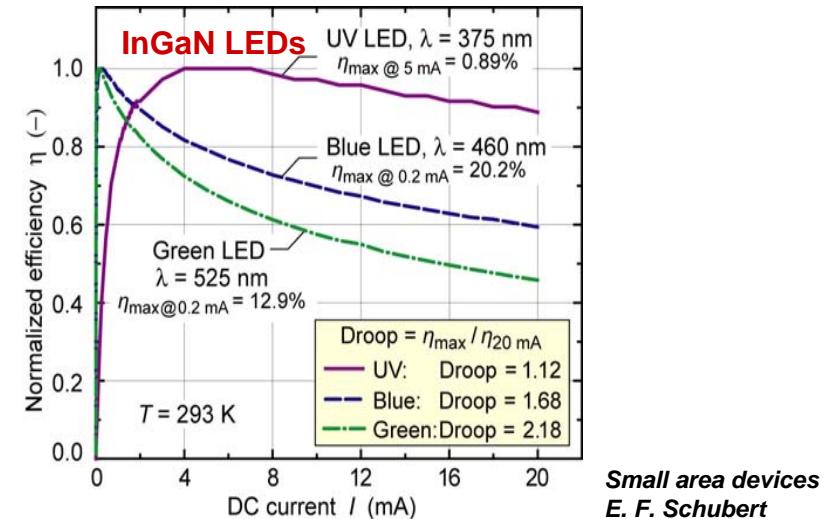


# RGB LED performance limitations

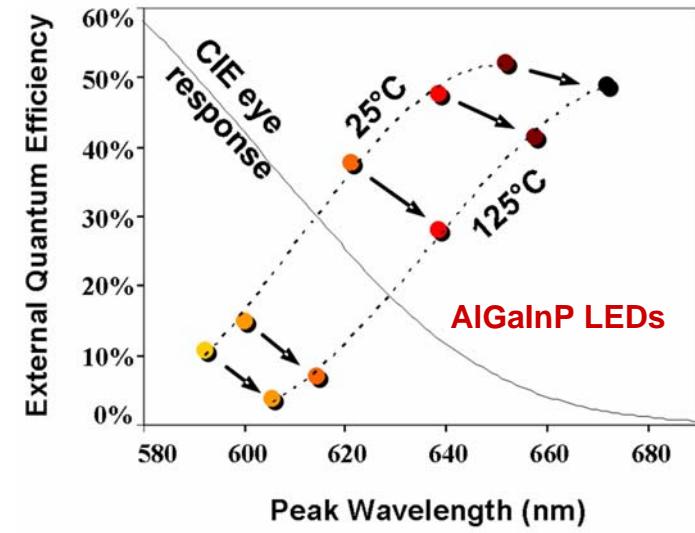
## Efficiency vs. Wavelength



## Blue/Green limitations → IQE and Efficiency Droop

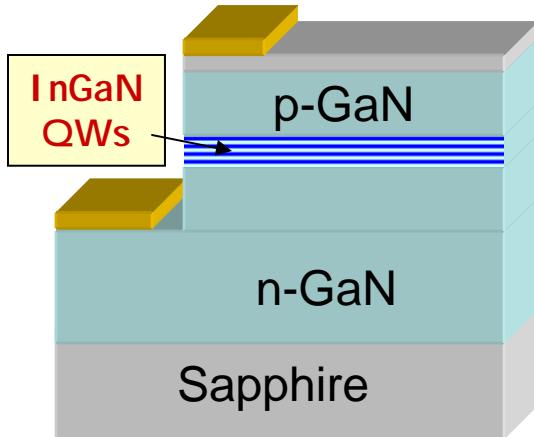


## AlGalnP short red limitations → Temperature



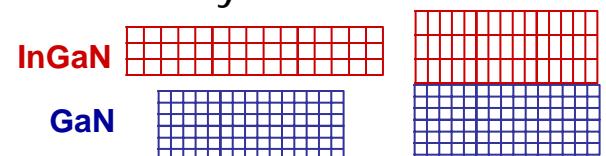
# Materials Challenges of InGaN LEDs

The green-yellow efficiency loss is inextricably linked with the evolution of InGaN materials properties with increasing indium composition of the alloy

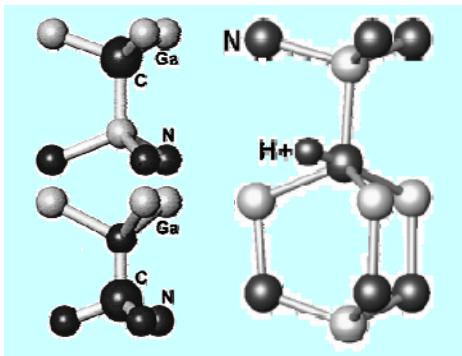


## Major materials issues related to high indium alloys:

- Thermal instability → require lower growth temperatures  
→ potential for increased impurities, defects, 3D growth
- Lattice-mismatch strain when grown on GaN epilayers  
→ reduced indium incorporation efficiency  
→ compositional instabilities  
→ enhanced defect formation  
→ piezoelectric polarization

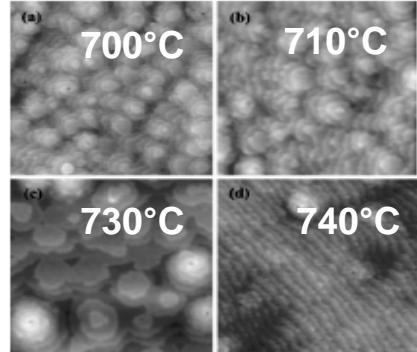


### Impurities and point defects



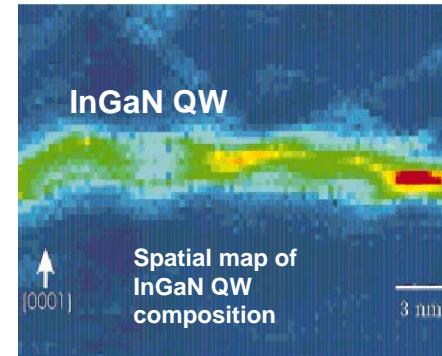
Wright et al., JAP 2002

### 3D growth modes



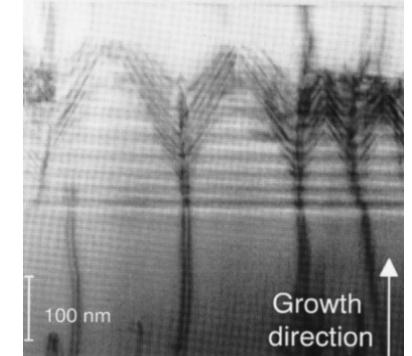
Oliver et al., JAP 2005

### Compositional instabilities



Gerthsen, et al., Phys. Stat. Sol. A (2000)

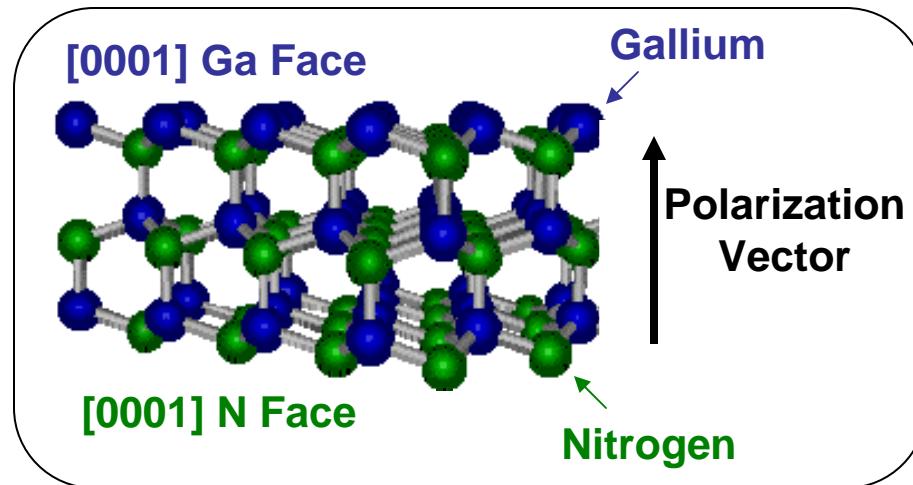
### “V- defects”



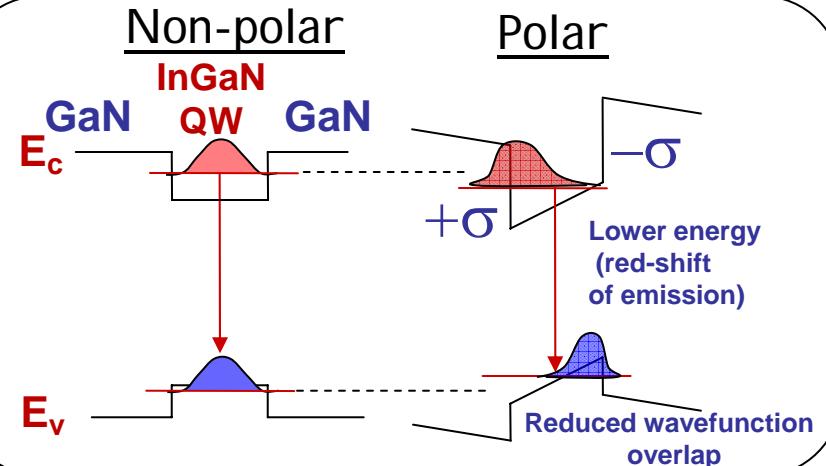
Scholz et al. Mat Sci & Eng B (1997)

# Polarization effects in InGaN LEDs

## Hexagonal (Wurzite) GaN crystal structure



## Effect on InGaN quantum well



- Dominated by piezoelectric (strain-driven) polarization for InGaN QWs on GaN
- Internal E-fields cause reduced electron-hole overlap → reduced radiative efficiency
- E-fields shift emission to longer wavelengths; → **blue-shifts with current**
- Significant band-bending creates barriers to carrier flow and/or reduced carrier confinement

Role in the “green-yellow gap”?

## Full LED structure

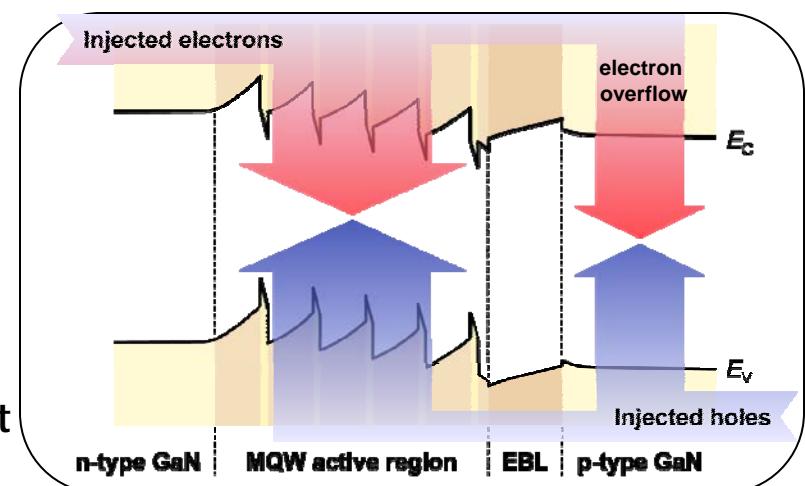
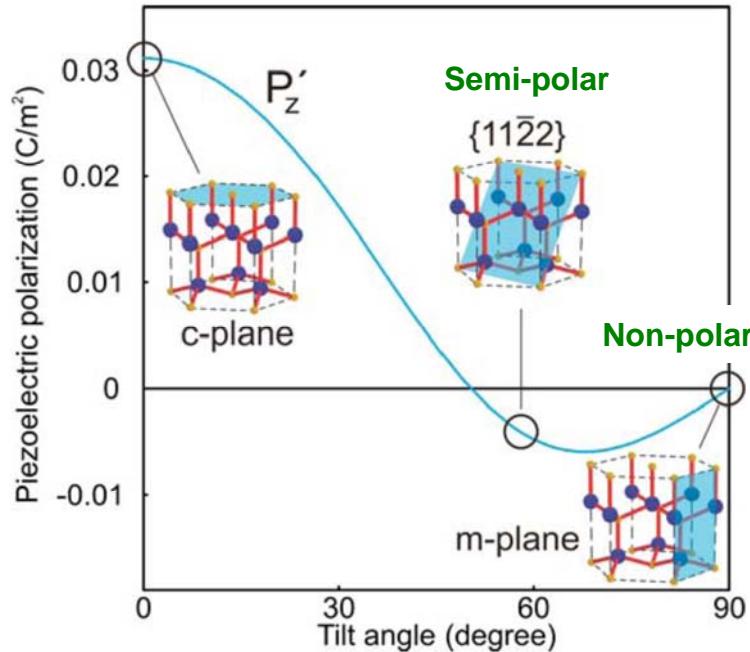


Figure: E. F. Schubert (RPI)

# Non-polar and Semi-polar Nitrides

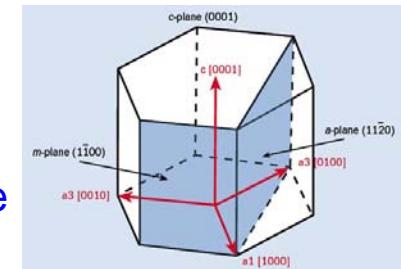
## Piezoelectric polarization vs. crystal orientation



## Challenges and recent advances:

- **Poor material quality:** high stacking fault densities in non-polar (e.g., *a*-plane GaN on *r*-plane sapphire)

→ **Breakthrough:**  
high quality HVPE  
c-plane GaN substrates;  
Sectioned into alternative  
orientations



- **Indium incorporation:** higher compositions needed than for c-plane (no red-shift); evidence of 2-3X lower incorporation on non-polar planes

→ **Semipolar:** (11-22), indium incorporation efficiency may be similar to c-plane

# Non-Polar/Semi-polar LEDs and the Green-Yellow Gap

## Highlights of nonpolar/semipolar LEDs:

- **Near-UV (402 nm) *m*-plane LED EQE~45%** (comparable to c-plane); blue (468 nm) EQE ~16.8%@ 20 mA  
*Kim et al., PSS RRL, 2007 (UCSB)*
- **Yellow (563 nm) Semipolar (11-22) LED; 5.9mW@ 20 mA**  
→ reportedly most efficient LED at this  $\lambda$  (**EQE~13%**)  
*Sato et al., Appl. Phys. Lett, 2008 (UCSB)*

## *m*-plane (non-polar) LED output vs. $\lambda$

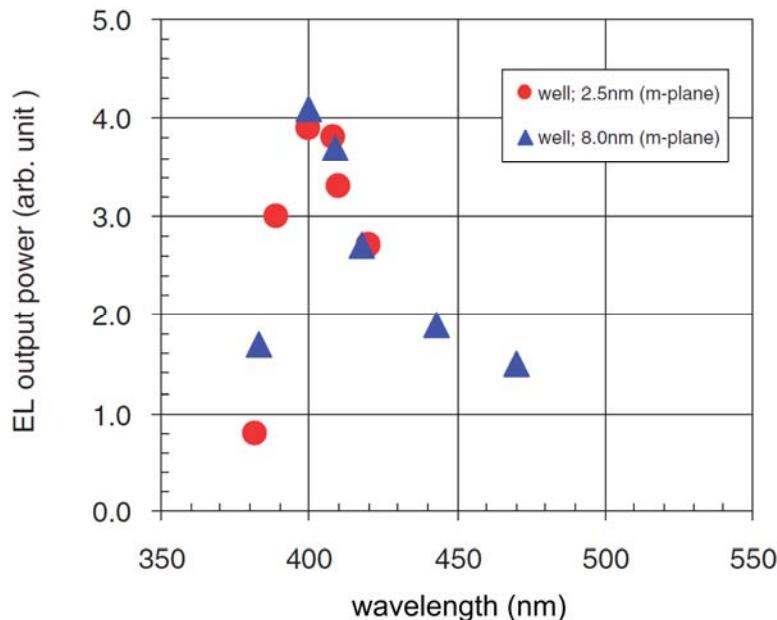
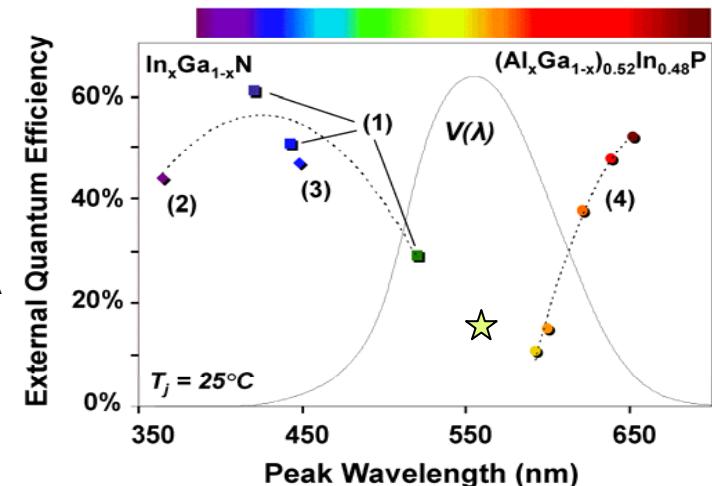


Figure: Yamada et al., Appl. Phys. Express, 2008

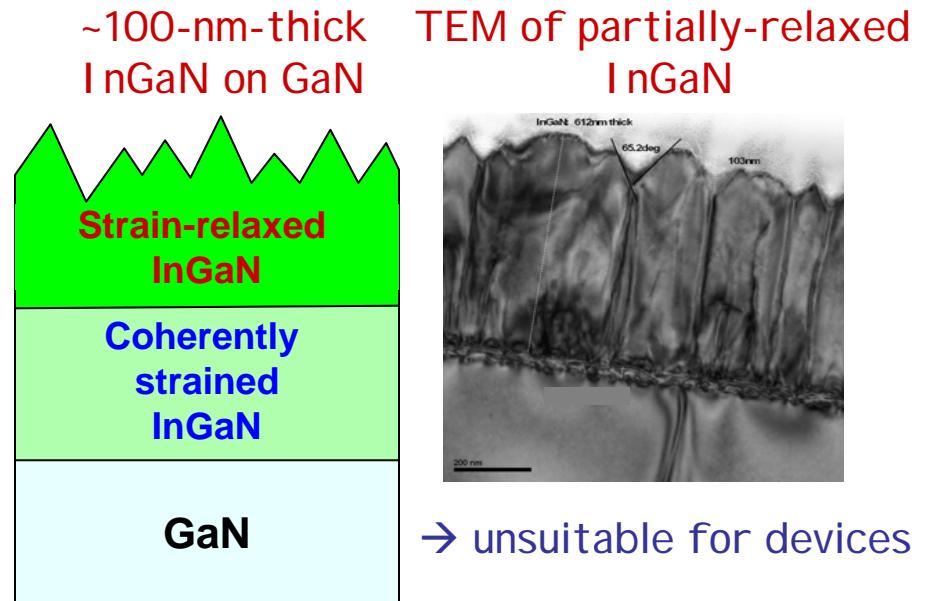
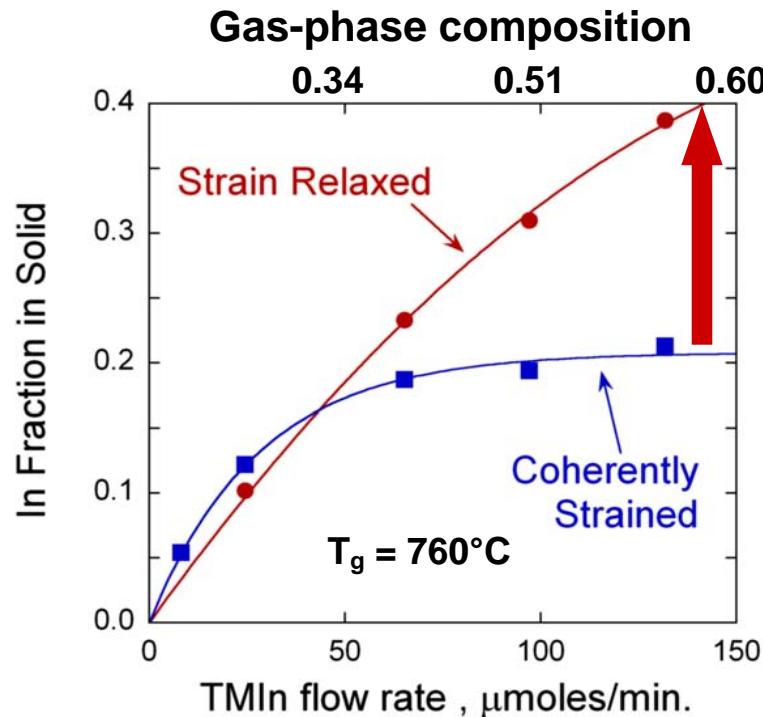


- **Study of *m*-plane LEDs as a function of emission wavelength**
- **Similar to c-plane LEDs, peak efficiency in near-UV / Violet; dropping at longer  $\lambda$**

Efficiency loss toward green seen even in the absence of polarization

# Additional Strain Effects in InGaN LEDs

→ Strain limits indium incorporation, important for longer wavelengths



- Elimination of strain enables higher indium incorporation at a given growth condition
- Reduced strain may help to avoid lower growth temperatures and related detrimental effects (impurity/defect incorporation, 3D growth modes)

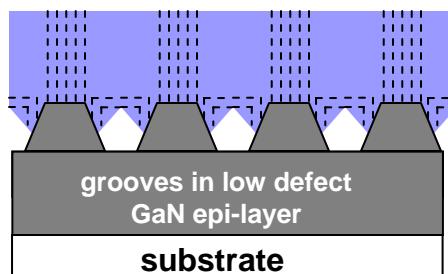
To enable long wavelength InGaN QW LEDs with reduced strain:

Possible to develop a *strain-relaxed InGaN substrate* with high crystalline quality and a smooth surface?

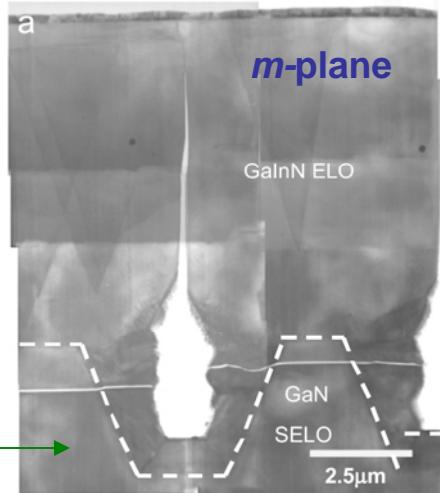
# Emerging InGaN Template/Substrate Solutions

## Strain-relaxed InGaN-on-GaN

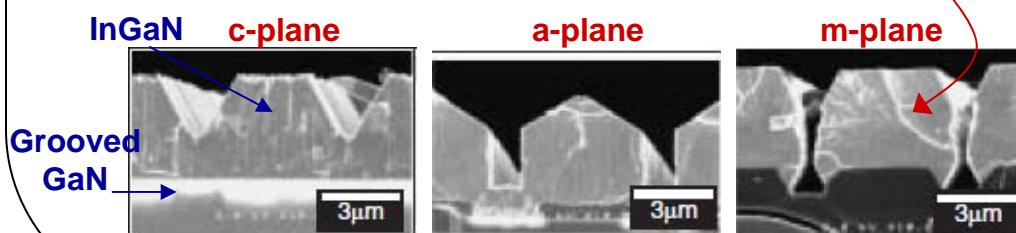
### InGaN overgrowth on Grooved GaN



Starting template  
*m*-plane GaN with grooves  
etched along  $<0001>$



- strain-relaxed 7 μm thick  $\text{In}_{0.07}\text{Ga}_{0.93}\text{N}$
- $< 1 \times 10^8 \text{ cm}^{-2}$  threading dislocation density
- Growth on *m*-plane key to planar InGaN



## Alternative Approaches

### InGaN growth on ZnO substrates

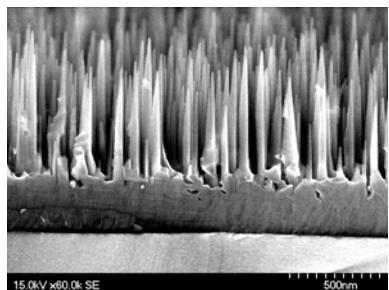
- Lattice match for  $\text{In}_{0.18}\text{Ga}_{0.82}\text{N}$
- Challenge: ZnO requires lower growth temperatures ( $< 650^\circ\text{C}$ ); leads to inferior InGaN crystalline quality
- Progress: Non-polar ZnO, pulsed laser deposition

### InGaN HVPE Substrates and LEDs

- High growth rate, low cost technique; yields high quality GaN templates
- InGaN significantly more challenging
- On-going development by TDI, Inc.  
→ Next presentation (A. Syrkin)

# Nanostructured InGaN Materials

## GaN nanowires (nanorods)



*Li et al., Appl. Phys. Lett. (2008)*

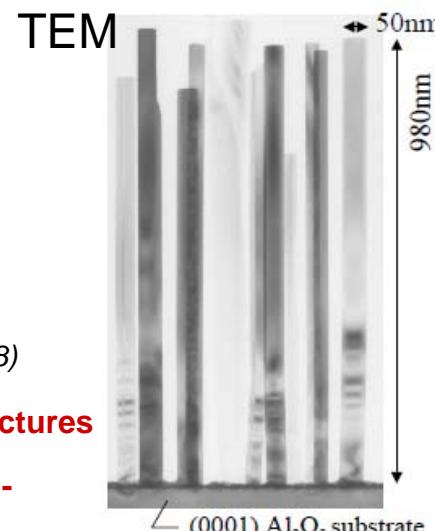
- highly aligned “1D” structures
- Self-assembly or directed-assembly approaches

## No threading defects

No threading defects

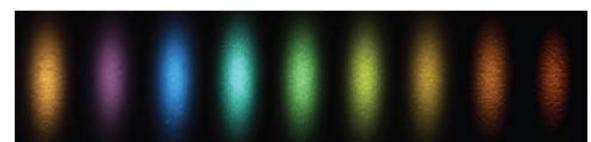
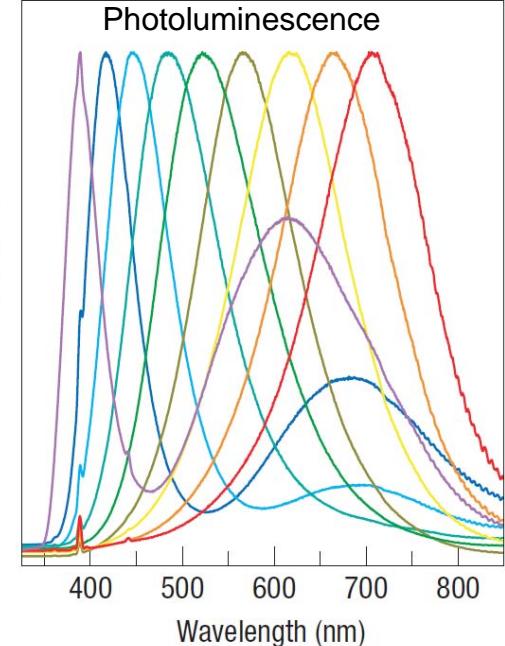
## Strain Accommodation

Strain Accommodation



*Kishino et al., Proc. SPIE 2007*

## Broad range of emission $\lambda$



*Growth by Halide Chemical Vapor Deposition*

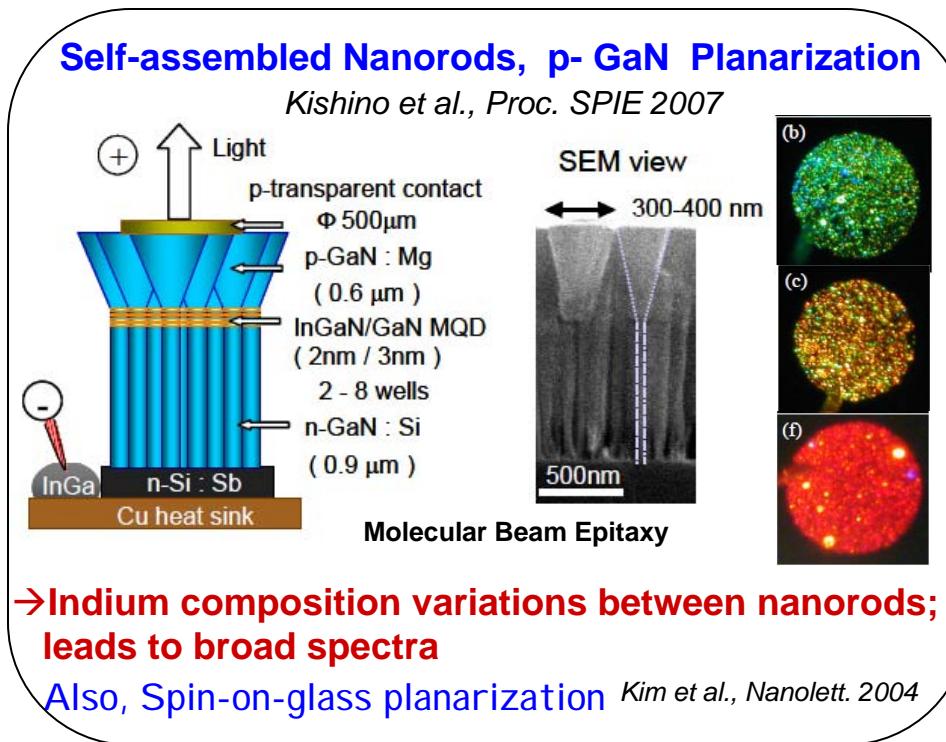
*Kuykendall et al., Nat Mat. 2007*

- Compatible with a wide range of substrates ( including Si)  
→ lower cost, integration possibilities
- Can be grown with no threading defects  
→ higher radiative efficiency
- Lateral structure allows strain accommodation  
→ greater indium composition/color range possible
- 1D geometry may provide light extraction benefits  
→ higher external quantum efficiency

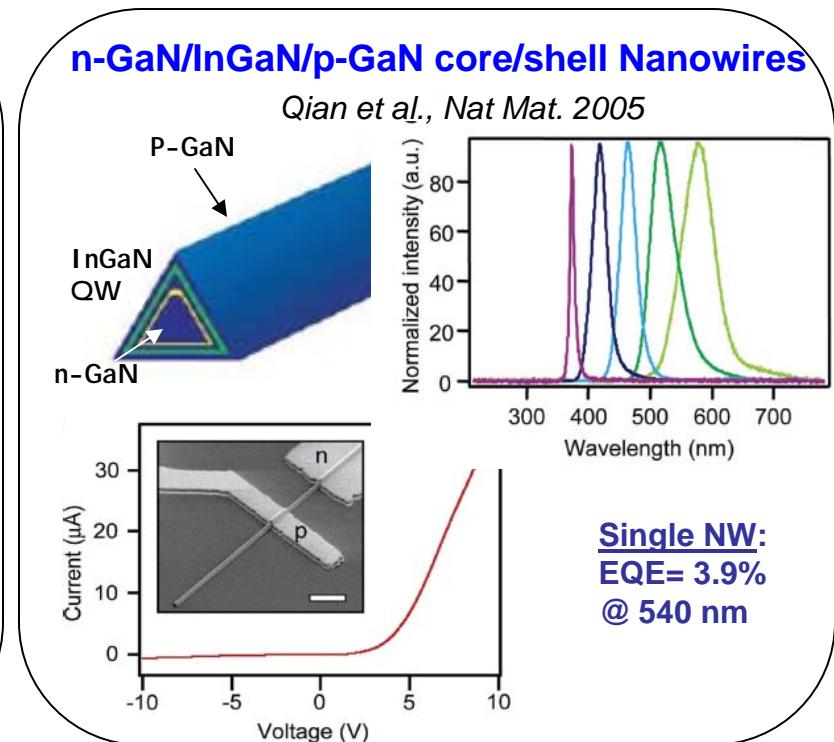
★ Potential for solving  
red problem also?

# Nanostructured InGaN LEDs

## Axial LED Geometries

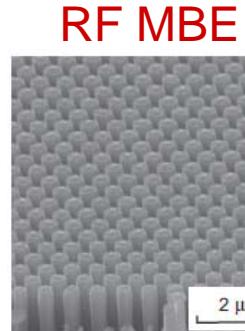


## Radial (Core-Shell) LED Geometries

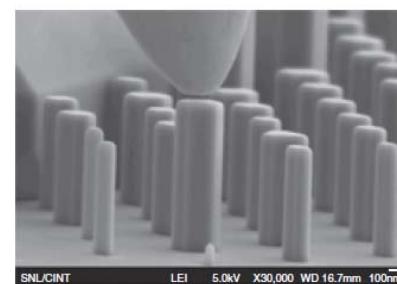


## Outstanding Issues:

- NW uniformity for InGaN composition and color control  
 → Selective area growth
- Device architectures



*Kishino et al., JCG 2009*

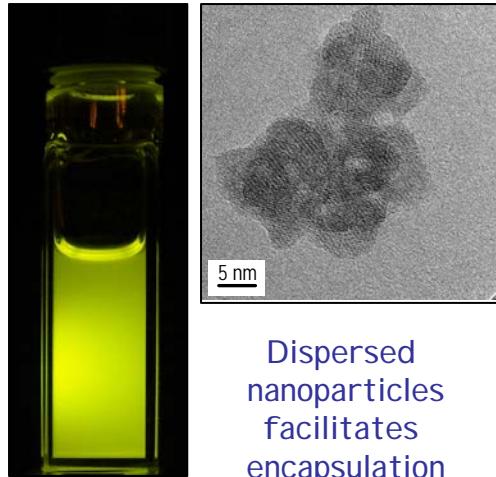


*Hersee et al., Electron. Lett. 2009*

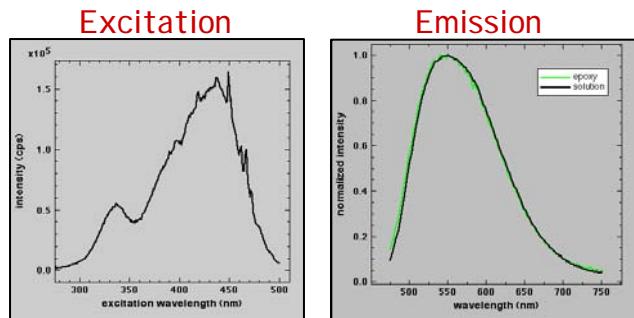
# Avenues for Green Phosphor Advances

## Nanostructured YAG:Ce

→ Reduced scattering losses



Dispersed nanoparticles facilitates encapsulation



- Bulk optical properties preserved
- Quantum Yield ~45% → promising

M. Nyman, Chemistry of Materials, (2009)  
(Sandia)

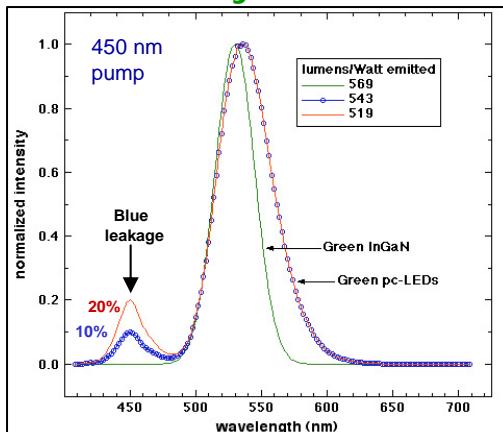
## Alternatives to YAG:Ce Phosphor

### LED or Phosphor

### Luminous Efficiency of Radiation

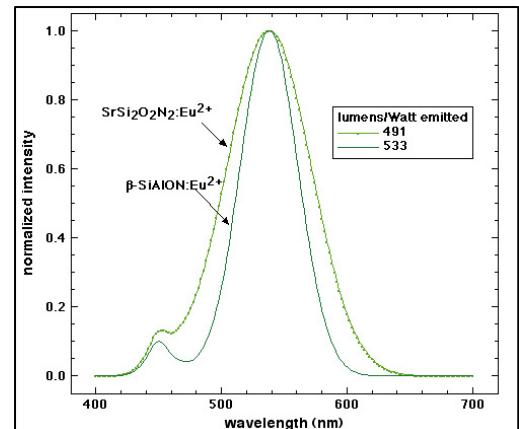
Green LED: FWHM 35 nm, $\lambda_{pk}=535$ nm.....	569 lm/W <sub>em</sub>
Commercial YAG:Ce.....	394 lm/W <sub>em</sub>
<b>SrGa<sub>2</sub>S<sub>4</sub>:Eu<sup>2+</sup></b> .....	564 lm/W <sub>em</sub>
<b>SrSi<sub>2</sub>O<sub>2</sub>N<sub>2</sub>:Eu<sup>2+</sup></b> , FWHM 78 nm, $\lambda_{pk}=538$ nm.....	506 lm/W <sub>em</sub>
<b><math>\beta</math>-SiAlON:Eu<sup>2+</sup></b> , FWHM 55 nm, $\lambda_{pk}=538$ nm.....	556 lm/W <sub>em</sub>

### Ternary Sulfides



- PC-LEDs using **SrGa<sub>2</sub>S<sub>4</sub>:Eu<sup>2+</sup>**
  - QY~ 80%
  - Moisture sensitivity
  - Strong thermal quenching
- PC-LEDs using nitride phosphors
  - QY~90%, small Stokes' shift
  - Good stability
  - Manufacturing challenges

### Covalent Nitrides



strontium thiogallate pc-LED:  
R. Mueller-Mach et al., IEEE JSTQE 2002

# Conclusions

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- Focus on blue LED efficiency improvements is yielding impressive performance advances for phosphor-converted white LEDs
- Multi-chip white LEDs hold tremendous promise for achieving ultra-efficient solid-state white lighting, but must overcome the green-yellow gap in LED efficiency
- Emerging approaches for InGaN LEDs in the green-yellow gap:
  - Semipolar LEDs** ( up to 563 nm yellow)
    - reduced polarization and sufficient indium incorporation
  - Strain relaxed InGaN templates**
    - extension of lateral overgrowth approaches to non-polar InGaN for strain relief in concert with defect reduction and planar surfaces
  - Nanostructured LEDs**
    - Advantages in strain accommodation and defect reduction, axial and radial LED geometries for green, yellow and red being explored